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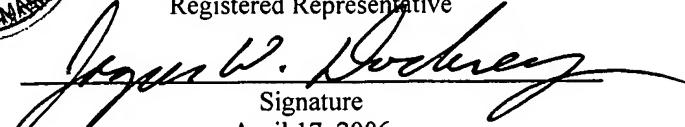
Alexandria, VA 22313-1450

on April 17, 2006

Date of Deposit

 Jasper W. Dockrey, Reg. No. 33,868

Name of applicant, assignee or
Registered Representative

 Signature

April 17, 2006

Date of Signature

Our Case No. 10808/121

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: SUNG, Kwon O.

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Examiner: E.B. Chen

Serial No.: 10/751,257

)

Group Art Unit No.: 1765

Filing Date: April 17, 2006

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For: METHOD OF MANUFACTURING A
LAYER SEQUENCE AND A
METHOD OF MANUFACTURING
AN INTEGRATED CIRCUIT

AMENDMENT AND RESPONSE UNDER 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Office Action of November 15, 2005, in the above-referenced application, please reconsider the rejection in view of the amendment and remarks presented herein.

Amendment of the claims appears in the listing of claims that begins at page 2 of this paper. Applicants' remarks begin at page 6 of this paper.